# 60V, 184A, 2.5mΩ N-channel Power SGT MOSFET

## JMSH0603PE

#### **Features**

- $\bullet \quad \text{Excellent $R_{\text{DS(ON)}}$ and Low Gate Charge}$
- 100% UIS Tested
- 100% ΔVds Tested
- Halogen-free; RoHS-compliant

### **Product Summary**

Parameters	Value	Unit
$V_{DSS}$	60	<b>V</b>
$V_{GS(th)\_Typ}$	2.6	V
$I_D(@V_{GS}=10V)$	184	Α
$R_{DS(ON)\_Typ}(@V_{GS}=10V$	2.5	mΩ

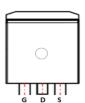


### **Applications**

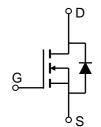
- Load Switch
- PWM Application
- Power Management



TO-263-3L



**Pin Assignment** 



**Schematic Diagram** 

#### **Ordering Information**

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
JMSH0603PE-13	SH0603P	3	Tape&Reel	TO-263-3L	800	4000

### **Absolute Maximum Ratings** (@ T<sub>C</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Unit
$V_{DS}$	Drain-to-Source Voltage		60	V
$V_{GS}$	Gate-to-Source Voltage		±20	V
I_	Continuous Drain Current	$T_C = 25^{\circ}C$	184	Λ
I <sub>D</sub>	Continuous Drain Current	$T_C = 100$ °C	116	- A
I <sub>DM</sub>	Pulsed Drain Current (1)		Refer to Fig.4	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy (2)		389	mJ
P <sub>D</sub>	DOWAR DISSIDATION L	$T_C = 25^{\circ}C$	188	W
		$T_C = 100$ °C	75	VV
$T_{J}, T_{STG}$	Junction & Storage Temperature Range		-55 to 150	°C

#### **Thermal Characteristics**

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <sup>(3)</sup>	33	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.7	C/VV



### **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	racteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	60	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 48V, V_{GS} = 0V$	-	-	1.0	μА
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics	•				
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.8	2.6	3.4	V
R <sub>DS(ON)</sub>	Static Drain-Source ON-Resistance <sup>(4)</sup>	$V_{GS} = 10V, I_D = 20A$	-	2.5	3.3	mΩ
Dynami	ic Characteristics					
$R_{g}$	Gate Resistance	f = 1MHz	-	2.2	-	Ω
C <sub>iss</sub>	Input Capacitance	., ., ., ., ., .,	2044	2862	3864	pF
C <sub>oss</sub>	Output Capacitance	$V_{GS} = 0V, V_{DS} = 30V,$ f = 1MHz	1082	1515	2045	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 11/11/12	56	79	106	pF
Qg	Total Gate Charge		34	48	64	nC
$Q_{gs}$	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 30V, I_{D} = 20A$	9	12	16	nC
$Q_{gd}$	Gate Drain("Miller") Charge	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 20A	9	13	17	nC
<b>0</b> 1/ 1 1						
	ing Characteristics	1		l	l	I
t <sub>d(on)</sub>	Turn-On DelayTime		-	13	-	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 30V$	-	29	-	ns
t <sub>d(off)</sub>	Turn-Off DelayTime	$I_D = 20A, R_{GEN} = 3\Omega$	-	36	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	16	-	ns
Body D	iode Characteristics			<u> </u>	T	ı
I <sub>S</sub>	Maximum Continuous Body Diode Forward Current		-	-	184	Α
I <sub>SM</sub>	Maximum Pulsed Body Diode Forward Curre	ent	-	-	736	Α
$V_{SD}$	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-		1.2	V
trr	Body Diode Reverse Recovery Time	I <sub>F</sub> = 20A, di/dt = 100A/us	36	51	69	ns
Qrr	Body Diode Reverse Recovery Charge	$r_{\rm F} = 20$ A, $r_{\rm H}$ $r_{\rm F} = 100$ A/US	-	60	-	nC

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

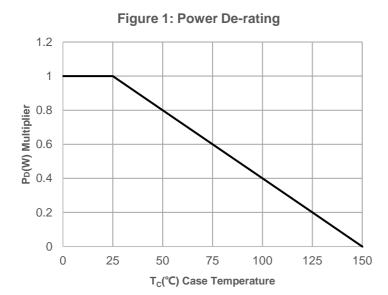
 $<sup>2.\</sup> E_{AS}\ condition:\ Starting\ T_J=25C,\ V_{DD}=30V,\ V_{GS}=10V,\ R_G=25ohm,\ L=3mH,\ I_{AS}=16.1A,\ V_{DD}=0V\ during\ time\ in\ avalanche.$ 

<sup>3.</sup>  $R_{\theta JA}$  is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB.

<sup>4.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  0.5%.



## **Typical Performance Characteristics**



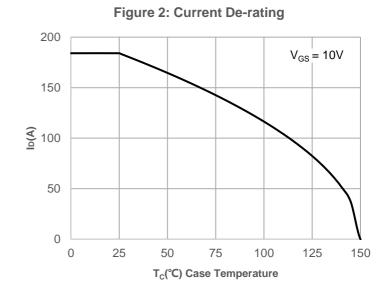
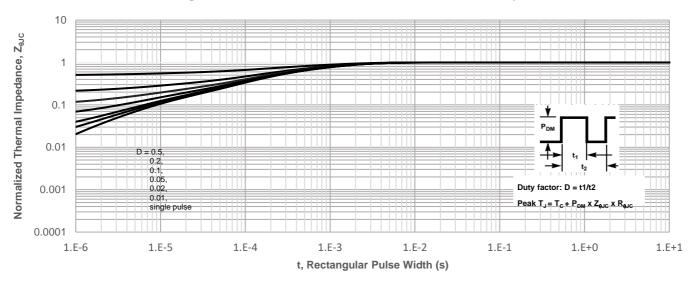
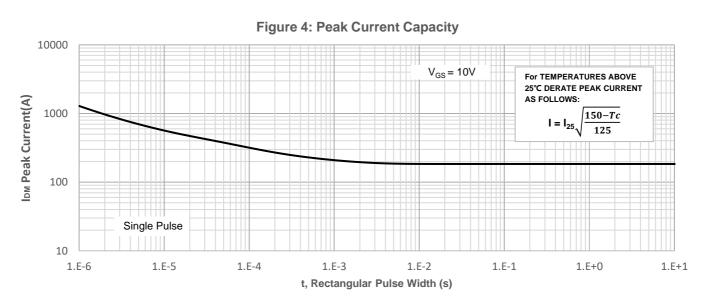


Figure 3: Normalized Maximum Transient Thermal Impedance

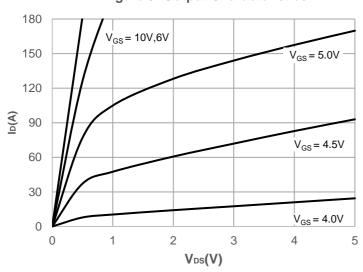






# **Typical Performance Characteristics**

**Figure 5: Output Characteristics** 



**Figure 6: Typical Transfer Characteristics** 

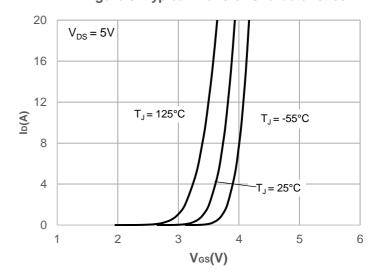
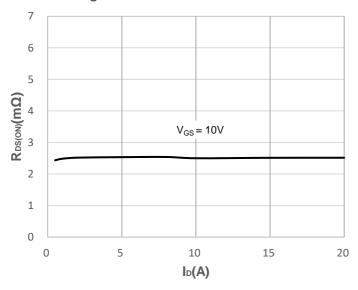
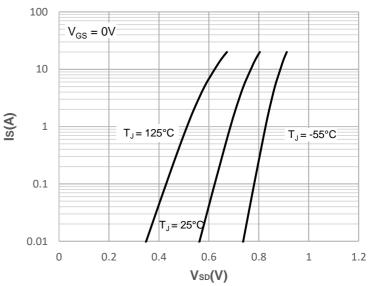


Figure 7: On-resistance vs. Drain Current



**Figure 8: Body Diode Characteristics** 



**Figure 9: Gate Charge Characteristics** 

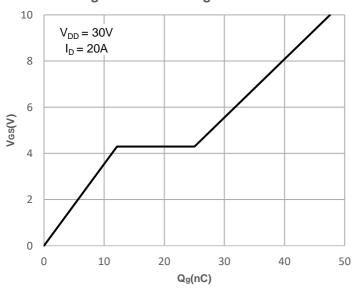
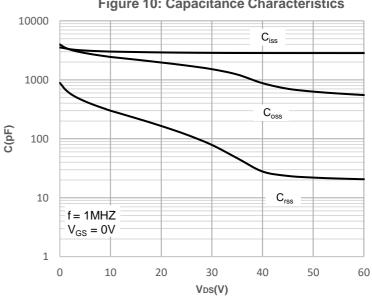


Figure 10: Capacitance Characteristics





# **Typical Performance Characteristics**

Figure 11: Normalized Breakdown voltage vs. Junction Temperature

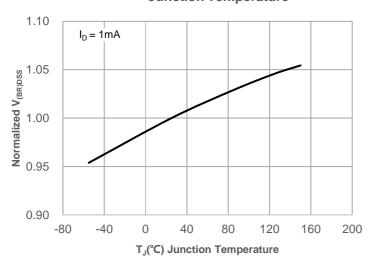


Figure 13: Normalized Threshold Voltage vs. Junction Temperature

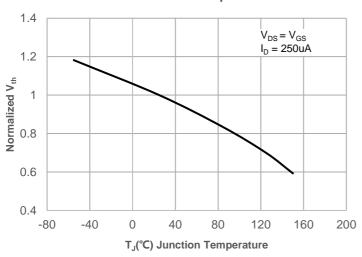


Figure 15: Maximum Safe Operating Area

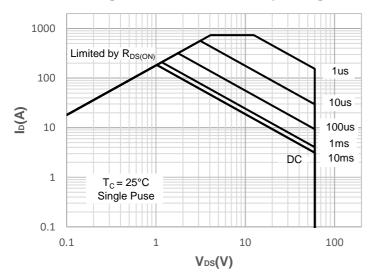
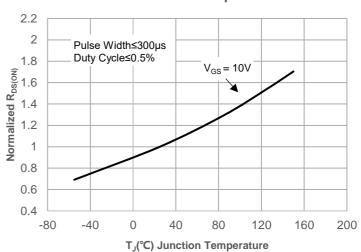
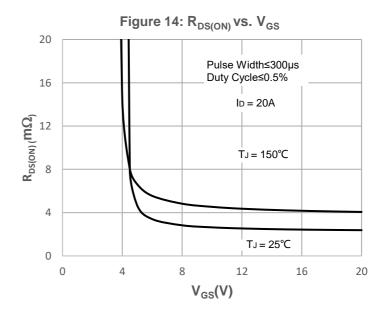


Figure 12: Normalized on Resistance vs. Junction Temperature







## **Test Circuit**

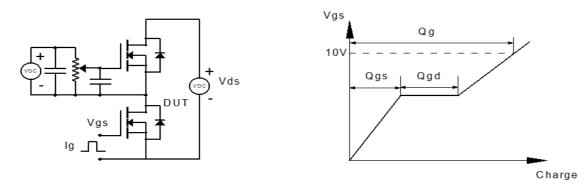


Figure 1: Gate Charge Test Circuit & Waveform

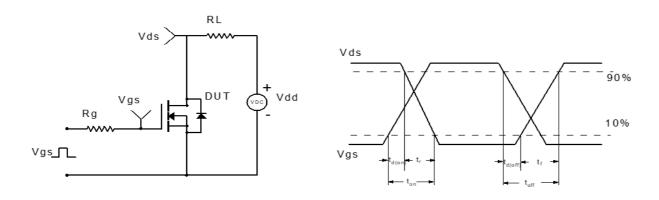


Figure 2: Resistive Switching Test Circuit & Waveform

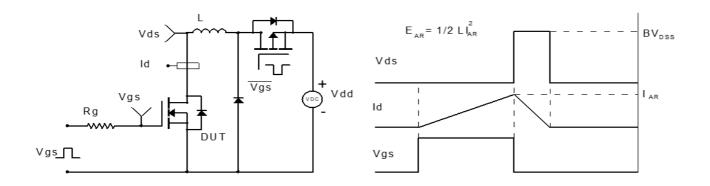


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

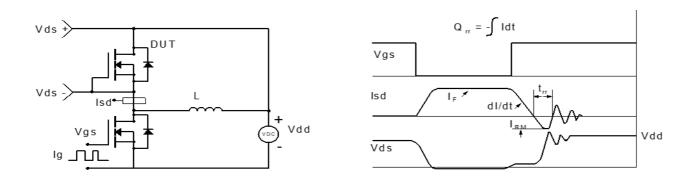
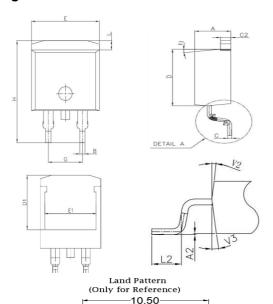


Figure 4: Diode Recovery Test Circuit & Waveform



## Package Mechanical Data(TO-263-3L)

#### **Package Outline**



SYMBOL		DIMENSIONS	S
STIVIBUL	MIN	NOM	MAX
Α	4.3	4.55	4.7
A2	0		0.15
В	0.75	0.8	0.85
С	0.38	0.46	0.55
C2	1.25	1.3	1.35
D	8.9	9.3	9.6
D1	7.4	7.65	7.9
E	9.9	10.05	10.21
E1	8.3	8.6	8.9
G	5.03	5.08	5.13
Н	14.7	15	15.8
L2	2.2	2.35	2.5
L	1.16	1.36	1.61

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